MOSFET - N-Channel, SUPERFET II, FRFET

600 V, 52 A, 72 m Ω

FCH072N60F-F085

Description

SUPERFET® II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently SUPERFETII is very well suited for the Soft switching and Hard Switching topologies like High Voltage Full Bridge and Half Bridge DC–DC, Interleaved Boost PFC, Boost PFC for HEV–EV automotive. SUPERFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- Typical $R_{DS(on)} = 62 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 26 \text{ A}$
- Typical $Q_{g(tot)} = 160 \text{ nC}$ at $V_{GS} = 10 \text{ V}$, $I_D = 26 \text{ A}$
- UIS Capability
- Qualified to AEC Q101 and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

Applications

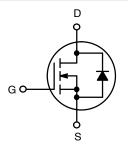
- Automotive On Board Charger
- Automotive DC/DC Converter for HEV



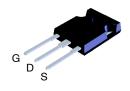
ON Semiconductor®

www.onsemi.com

V _{DSS} R _{DS(ON)} MAX		I _D MAX	
600 V	72 m Ω	52 A	



N-Channel MOSFET



TO-247 CASE 340CK

MARKING DIAGRAM



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Data Code (Year & Week)

&K = Lot Code

FCH072N60F = Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

Symbol	Parameter	Ratings	Unit	
V _{DSS}	Drain to Source Voltage		600	V
V _{GS}	Gate to Source Voltage		±20	V
Ι _D		: 25°C : 100°C	52 33	Α
	Pulsed Drain Current		See Fig. 4	
E _{AS}	Single Pulsed Avalanche Rating (Note 2)		1128	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
P_{D}	Power Dissipation		481	W
	Derate Above 25°C		3.85	W/°C
T _J , T _{STG}	Operating and Storage Temperature (Note 4)		-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Current is limited by bondwire configuration.

- Current is limited by borldwire comiguration.
 Starting T_J = 25°C, L = 25 mH, I_{AS} = 9.5 A, V_{DD} = 100 V during inductor charging and V_{DD} = 0 V during time in avalanche.
 I_{SD} ≤ 26 A, di/dt ≤ 200 A/μs, V_{DD} ≤ 380 V, starting T_J = 25°C.
 R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJC} is gauarenteed by design, while R_{θJA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

THERMAL CHARACTERISTICS

Symbol	Parameter	Ratings	Unit
$R_{ hetaJC}$	Thermal Resistance, Junction to Case, Max.	0.26	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Quantity
FCH072N60F-F085	FCH072N60F	TO-247-3LD	-	-	30

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
FF CHARAC	TERISTICS	•		•		
BV _{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600	_	_	V
I _{DSS}	Drain to Source Leakage Current	V _{DS} = 600 V, V _{GS} = 0 V, T _J = 25°C	_	_	10	μΑ
		V _{DS} = 600 V, V _{GS} = 0 V, T _J = 150°C (Note 5)	-	-	1	mA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V	-	_	±100	nA
N CHARACT	ERISTICS	•	•			
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	3.0	4.0	5.0	V
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10 V, I _D = 26 A, T _J = 25°C	-	62	72	mΩ
		V _{GS} = 10 V, I _D = 26 A, T _J = 150°C (Note 5)	-	154	195	mΩ
YNAMIC CHA	ARACTERISTICS	•	•			
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		6330	_	pF
C _{oss}	Output Capacitance	7	_	199	-	pF
C _{rss}	Reverse Transfer Capacitance	7	_	1.25	-	pF
Rg	Gate Resistance	f = 1 MHz	-	0.46	-	Ω
Q _{g(TOT)}	Total Gate Charge	V _{DD} = 380 V, I _D = 26 A, V _{GS} = 10 V	_	160	210	nC
Q _{g(th)}	Threshold Gate Charge	7	_	11	16	nC
Q _{gs}	Gate to Source Gate Charge	7	_	34	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		_	67	-	nC
WITCHING C	HARACTERISTICS					
t _{on}	Turn-On Time	V _{DD} = 380 V, I _D = 26 A,	-	75	100	ns
t _{d(on)}	Turn-On Delay Time	$V_{GS} = 10 \text{ V}, R_{G} = 4.7 \Omega$	-	44	-	ns
t _r	Rise Time	1	-	31	-	ns
t _{d(off)}	Turn-Off Delay Time	1	-	128	-	ns
t _f	Fall Time	1	-	22	-	ns
t _{off}	Turn-Off Time		_	150	200	ns
RAIN-SOUR	CE DIODE CHARACTERISTICS					
V_{SD}	Source to Drain Diode Voltage	I _{SD} = 26 A, V _{GS} = 0 V	-	_	1.2	V
T _{rr}	Reverse Recovery Time	$I_F = 26 \text{ A}, dI_{SD}/dt = 100 \text{ A}/\mu\text{s}$	-	185	-	ns
Q _{rr}	Reverse Recovery Charge	V _{DD} = 480 V	-	1515	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. The maximum value is specified by design at T_J = 150°C. Product is not tested to this condition in production.

TYPICAL CHARACTERISTICS

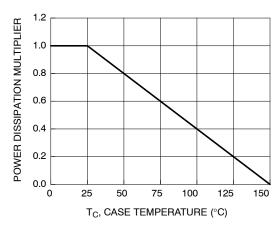


Figure 1. Normalized Power Dissipation vs. Case Temperature

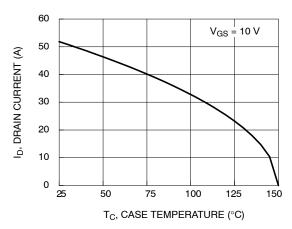


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

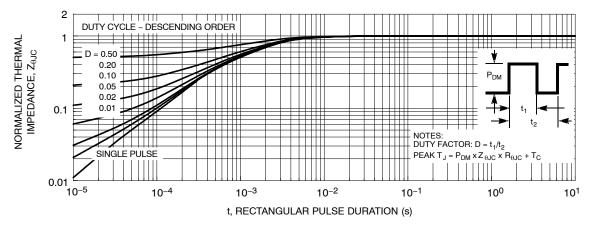


Figure 3. Normalized Maximum Transient Thermal Impedance

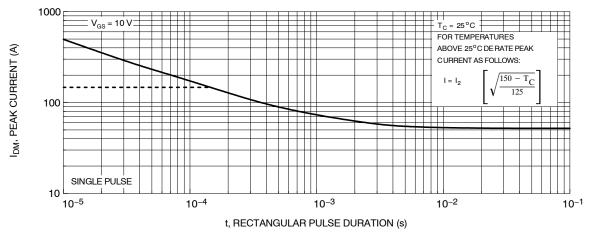


Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS (continued)

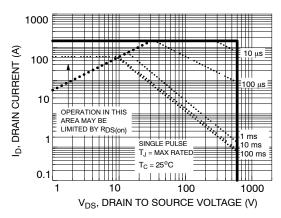


Figure 5. Forward Bias Safe Operating Area

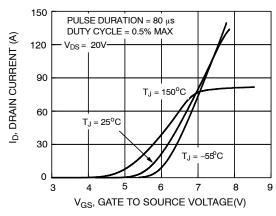


Figure 6. Transfer Characteristics

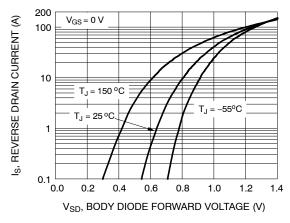


Figure 7. Forward Diode Characteristics

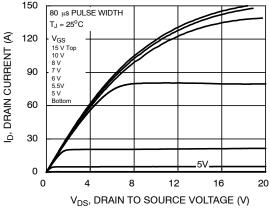


Figure 8. Saturation Characteristics

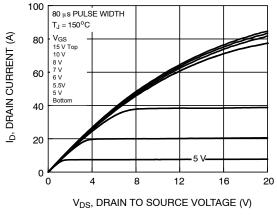


Figure 9. Saturation Characteristics

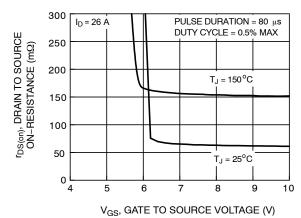


Figure 10. R_{DSON} vs. Gate Voltage

TYPICAL CHARACTERISTICS (continued)

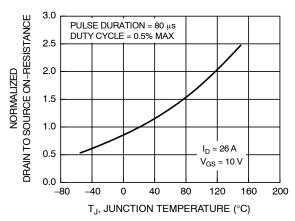


Figure 11. Normalized R_{DSON} vs. Junction Temperature

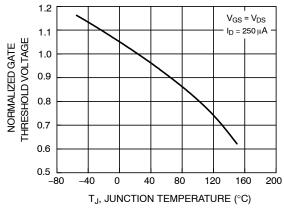


Figure 12. Normalized Gate Threshold Voltage vs. Temperature

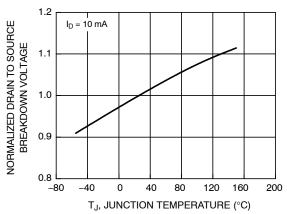


Figure 13. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

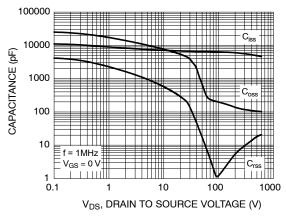


Figure 14. Capacitance vs. Drain to Source Voltage

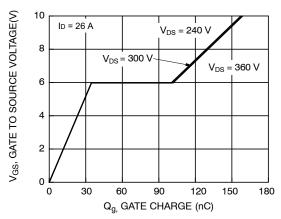


Figure 15. Gate Charge vs. Gate to Source Voltage

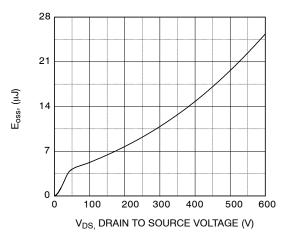


Figure 16. Eoss vs. Drain to Source Voltage

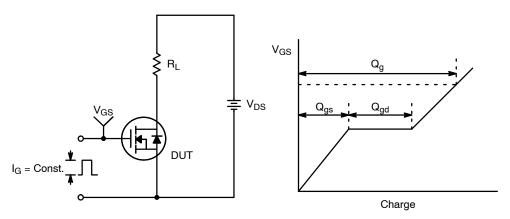


Figure 17. Gate Charge Test Circuit & Waveform

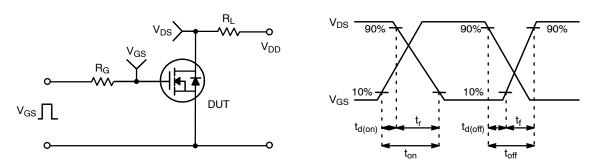


Figure 18. Resistive Switching Test Circuit & Waveforms

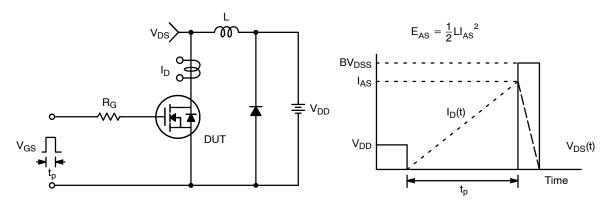


Figure 19. Unclamped Inductive Switching Test Circuit & Waveforms

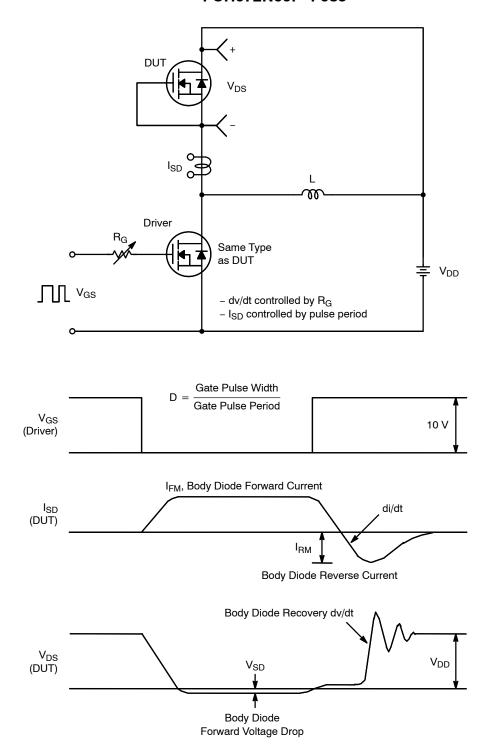


Figure 20. Peak Diode Recovery dv/dt Test Circuit & Waveforms

SUPERFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. FRFET is a registered trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other

countries.

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS				
DIIVI	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
A 1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51	0.61	0.71		
D	20.32	20.57	20.82		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
E	15.37	15.62	15.87		
E1	12.81	?	~		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	15.75	16.00	16.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
ØP1	6.60	6.80	7.00		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		

DOCUMENT NUMBER:	98AON13851G	Electronic versions are uncontrolled except when accessed directly from the Document Reposit Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TO-247-3LD SHORT LEAD		PAGE 1 OF 1	

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B